

PRESS RELEASE

Beside Announces 2013 First Quarter Results Release, Conference Call and Webcast Date

Duiven, the Netherlands, April 17, 2013 - BE Semiconductor Industries N.V. ("the Company" or "Beside") (Euronext: BESI; OTCQX: BESIY), a leading manufacturer of assembly equipment for the semiconductor industry, will release results for the first quarter ended March 31, 2013, on Wednesday, April 24, 2013 at 7.00 a.m. Central European Time (1.00 a.m. New York time).

Beside will host a conference call and audio webcast (log on via www.besi.com) to discuss its results for the first quarter ended March 31, 2013, on Wednesday, April 24, 2013 at 11.30 a.m. Central European Time (5.30 a.m. New York time). The teleconference dial-in number is (31) 20 531 5869. The audio webcast will remain available on www.besi.com.

About Beside

Beside is a leading supplier of semiconductor assembly equipment for the global semiconductor and electronics industries. The Company develops leading edge assembly processes and equipment for leadframe, substrate and wafer level packaging applications in a wide range of end-user markets including electronics, computer, automotive, industrial, RFID, LED and solar energy. Customers are primarily leading semiconductor manufacturers, assembly subcontractors and electronics and industrial companies. Beside's ordinary shares are listed on NYSE Euronext Amsterdam (symbol: BESI) and OTCQX International (symbol: BESIY) and its headquarters are located in Duiven, the Netherlands. For more information, please visit our website at www.besi.com.

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